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ON Semiconductor®

FDB9406-F085

N-Channel PowerTrench® MOSFET **40 V, 110 A, 1.8 m**Ω

Features

- Typ $R_{DS(on)}$ = 1.31m Ω at V_{GS} = 10V, I_D = 80A
- Typ $Q_{g(tot)}$ = 107nC at V_{GS} = 10V, I_D = 80A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and
- Primary Switch for 12V Systems

MOSFET Maximum Tatil 's Tie 5°C unless ctire, wise noted.

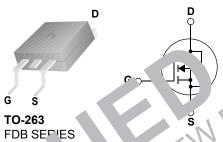
Symbol	Pa/2/neter	Ratings	Units
V_{DSS}	/ ain to Sou Vo' ye	40	V
V _{GS}	rce Voltage	±20	V
	Drain Cur .nt - Continuous (V _{GS} =10) (Note 1) Γ _C = 25°C	110	А
-	ulseu Drain Current T _C = 25°C	See Figure4	^
E _{AS}	Single Pulse Avalanche Energy (Note 2)	174	mJ
	Power Sissipation	176	W
	L'erate above 25°C	1.18	W/°C
T_J, T_{STG}	Operating and Storage Comperature	-55 to + 175	°C
$\mathcal{C}_{\theta \mathcal{I}}$	Thermal Resistance, Junction to Case	0.85	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)	43	°C/W
)			

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB9406	FDB9406-F085	D2-PAK(TO-263)	330mm	24mm	800 units

- Current is limited by bondwire configuration.
 Starting T_J = 25°C, L = 0.045mH, I_{AS} = 88A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche.
- 3: $R_{\theta,JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder

mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.



Units

Max.

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Parameter

Off Ch	aracteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, \	V _{GS} = 0V	40	-	-	V
	Drain-to-Source Leakage Current	V _{DS} =40V,	$T_{J} = 25^{\circ}C$	-	-	1	μΑ
DSS	Dialii-to-Source Leakage Current	$V_{GS} = 0V$	$T_J = 175^{\circ}C(Note 4)$	-	-	1	mA
loco	Gate-to-Source Leakage Current	$V_{00} = +20V$	·	_	_	+100	nΑ

Test Conditions

Min.

Тур.

On Characteristics

Symbol

V _{GS(th)}	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D}$	= 250µA	2.0	2.81		V
R _{DS(on)}	Drain-to-Source On Resistance	I _D = 80A,	$T_{J} = 25^{\circ}C$	1	1	1.ὲ	mΩ
		V _{GS} = 10V	$T_J = 175^{\circ}C(Note 4)$		2.2	2.8	mΩ

Dynamic Characteristics

C _{iss}	Input Capacitance	710 -	pF
		Vpc = 25V Vcc = 0V	•
C _{oss}	Output Capacitance	f = 1MHz	pF
C _{rss}	Reverse Transfer Capacitance	- 40 -	pF
R_g	Gate Resistance	f = 1MH - 2.7 -	Q
$Q_{g(ToT)}$	Total Gate Charge at 10V	V_C 1 to 10 $P_C = 32$ - 10 138	110
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 2V$ $I_D = 80A$ - $I_D = 10$	nC
Q_{gs}	Gate-to-Source Gate Charge	33	nC
Q_{gd}	Gate-to-Drain "Miller" Charge	N 2- 38V -	nC

Switching Character stics

t _{on} Turn-On	ne	-	-	160	ns
$t_{d(on)}$	y QV XV ZV	-	32	-	ns
t _r <ise t<="" td=""><td></td><td>-</td><td>81</td><td>-</td><td>ns</td></ise>		-	81	-	ns
t _{d(off)}	$V_{GS} = 10V + c_{EN} = 6\Omega$	-	50	-	ns
Fa	Mo O KIN	-	23	-	ns
t _{off} 'urn-Off'	Tirne	-	1	93	ns

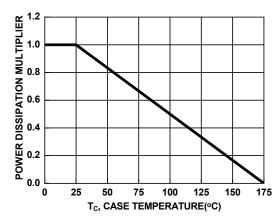
Prair Source Diode Characteristics

V_{SD}	Source-to-Orair. Diode Voltage	$I_{SD} = 80A, V_{GS} = 0V$	1	-	1.25	٧
t	Reverse-Recovery final	$I_F = 80A$, $dI_{SD}/dt = 100A/\mu s$,	-	85	110	ns
Ou	Reverse-Recovery Charge	V _{DD} =32V	-	122	160	nC

Note:

^{4:} The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production.

Typical Characteristics



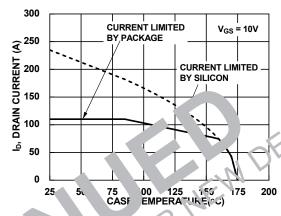
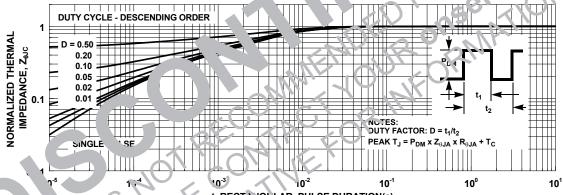


Figure 1. Normalized Power Dissipation vs. Case Temperature





t, RECTALGULAR PULSE DURATION(s)
Figure 3 Normalized Natimum Transient Thermal Impedance

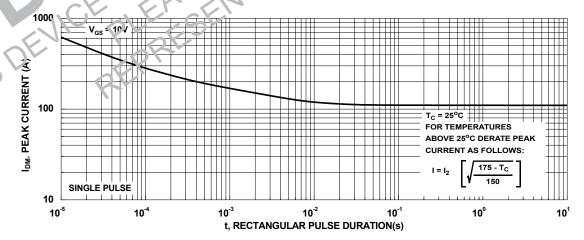


Figure 4. Peak Current Capability

Typical Characteristics

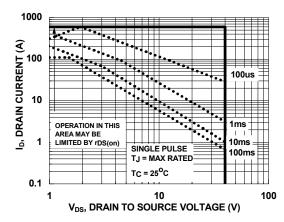
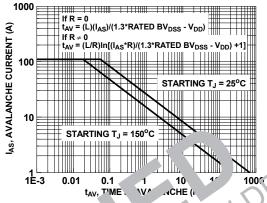
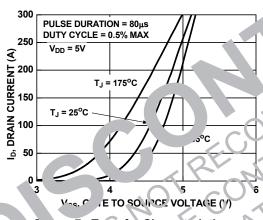


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Sem. nduc Applir on Note: AN75 \downarrow 4 and AN7515

Figure Un ampe Inductive Switching



F. re 7. Transfer Characteristics

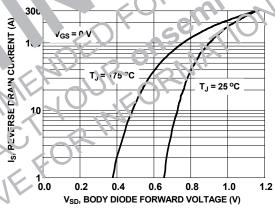


Figure 8. Forward Diode Characteristics

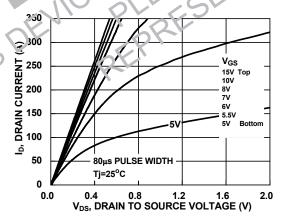


Figure 9. Saturation Characteristics

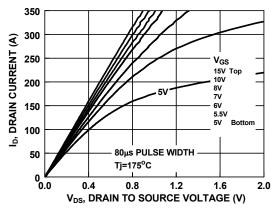


Figure 10. Saturation Characteristics

Typical Characteristics

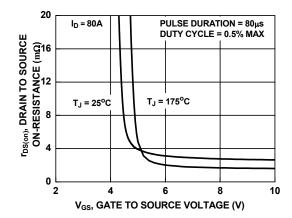


Figure 11. R_{DSON} vs. Gate Voltage

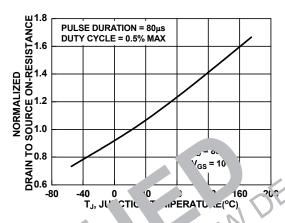
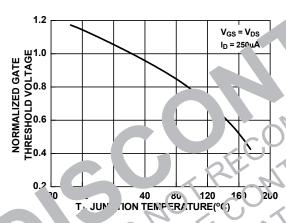


Figure 12 Norma rea SON vs. Junction Ten grature



Figu 13 Vormalized Gate Threshold Voltage vs.

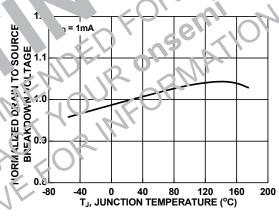


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

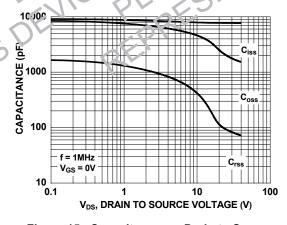


Figure 15. Capacitance vs. Drain to Source Voltage

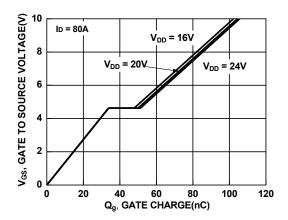


Figure 16. Gate Charge vs. Gate to Source Voltage



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